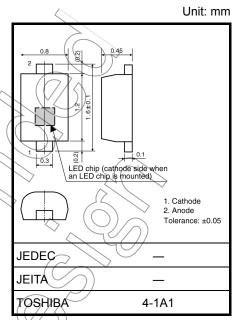
TOSHIBA LED Lamps

TLRH1032(T15,F), TLRMH1032(T15,F), TLSH1032(T15,F), TLOH1032(T15,F), TLYH1032(T15,F), TLGH1032(T15,F), TLFGH1032(T15,F)

Panel Circuit Indicators

- Surface-mount devices
- 1.6 (L) mm \times 0.8 (W) mm \times 0.45 (H) mm (including lead length)
- InGaAlP LEDs
- High luminous intensity and low power consumption
- Colors: red, orange, yellow, green, pure green
- Applications: backlighting for LCDs and switches for automotive applications.
- Standard embossed tape packing: T15 (8000 / reel)

2-mm pitch



Weight: 0.001 g (typ.)

Color and Material

Part Number	Color	Material			
TLRH1032	Red				
TLRMH1032	Red				
TLSH1032	Red				
TLOH1032	Orange	InGaAlP			
TLYH1032	Yellow				
TLGH1032	Green				
TLFGH1032	Fresh Green				

Absolute Maximum Ratings (Ta = 25°C)

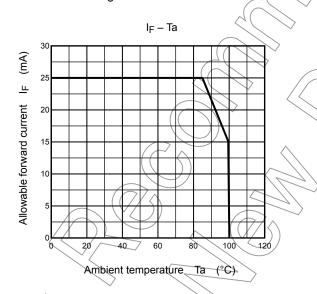
Part Number	Forward Current I _F (mA) See Note 1	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLRH1032					
TLRMH1032				<u> </u>	
TLSH1032			60		
TLOH1032	25	4		-40 to 100	_40 to 100
TLYH1032					
TLGH1032			62.5	$\langle (// \hat{\gamma}) \rangle$	
TLFGH1032			02.5		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability-significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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Note 1: Forward current derating



Electrical Characteristics (Ta = 25°C)

Part Number)) ၊	Forward \	oltage V _I			Current
	Min	(Typ,	Max) I _F	Max	V_{R}
TLRH1032	1.7	2.0	2.4			
TLRMH1032	1.7	2.0	2.4			
TLSH1032	1.7	2.0	2.4			
TLOH1032	1.7	2.0	2.4	20	10	4
TLYH1032	1.7	2.0	2.4			
TLGH1032	1.8	2.1	2.5			
TLFGH1032	1.9	2.2	2.5			
Unit		V		mA	μА	٧



Optical Characteristics-1 (Ta = 25°C)

Part Number	L	uminous	Intensity	lv	Available I _V rank
i ait ivuilibei	Min	Тур.	Max	lF	Please see Note 2
TLRH1032	25	56	125		NA / PA / QA
TLRMH1032	40	85	200		PA / QA / RA
TLSH1032	63	160	320		QA / RA / SA
TLOH1032	100	200	500	20	RA / SA / TA
TLYH1032	40	100	200		PA / QA / RA
TLGH1032	25	60	125		NA / PA / QA
TLFGH1032	10	25	50		LA / MA / NA
Unit	mcd	mcd	mcd	mA	- ((

Note 2: The specification on the above table is used for Iv classification of LEDs in Toshiba facility.

Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

Rank	Luminous Intensity I _V				
Nank	Min	Max			
LA	10	20			
MA	16	32			
NA	25	50			
PA	40	80			
QA	63	125			
RA	100	200			
SA	160	320			
TA	250	500			
Unit	mcd	mcd			

Optical Characteristics-2 (Ta = 25°C)

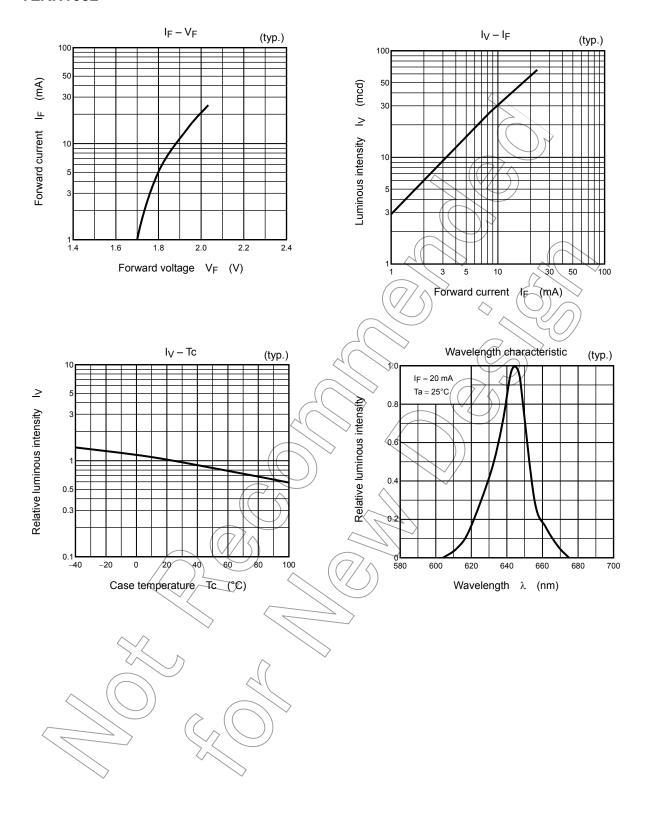
	//					/ ^		
				Emişsion	Spectrum			
Part Number		ak Emiss velength		Δλ	Dominar	nt Wavele	ength λ _d	ΙF
	Min	Тур,	Max <	Тур.	Min	Тур.	Max	
TLRH1032	$^{\wedge}$	644	_	17	624	630	638	
TLRMH1032	\ \ \	636	_ <	17	620	626	634	
TLSH1032		623	7	17	607	613	621	
TLOH1032)	612		17	599	605	613	20
TLYH1032)_	590		13	581	587	595	
TLGH1032		574		13	565	571	576	
TLFGH1032		568	_	11	560	565	571	
Unit		nm	<u> </u>	nm		nm		mA

The cautions

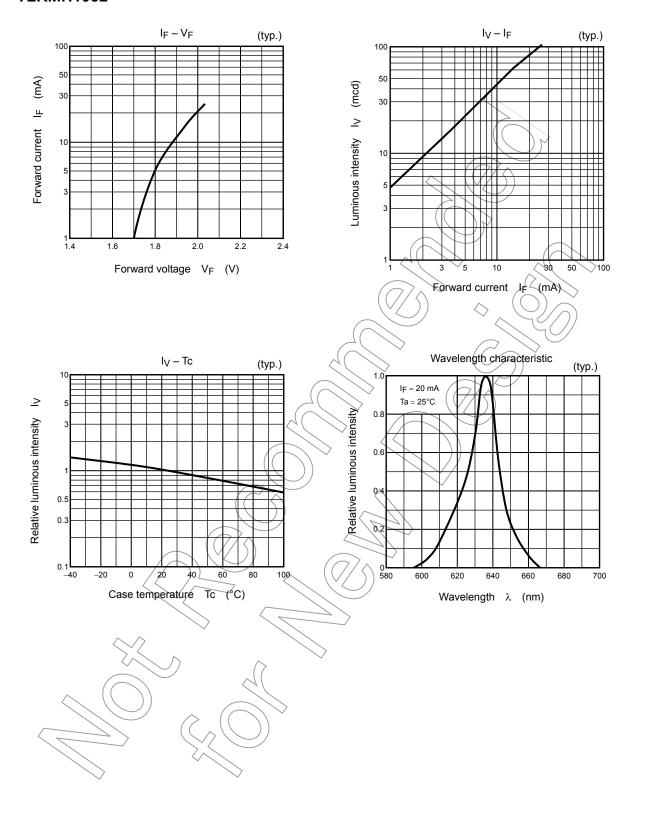
- This visible LED lamp also emits some IR light.

 If a photodetector is located near the LED lamp, please ensure that it will not be affected by the IR light.
- This product is designed as a general display light source usage, and it has applied the measurement standard that matched with the sensitivity of human's eyes. Therefore, it is not intended for usage of functional application (ex. Light source for sensor, optical communication and etc) except general display light source.

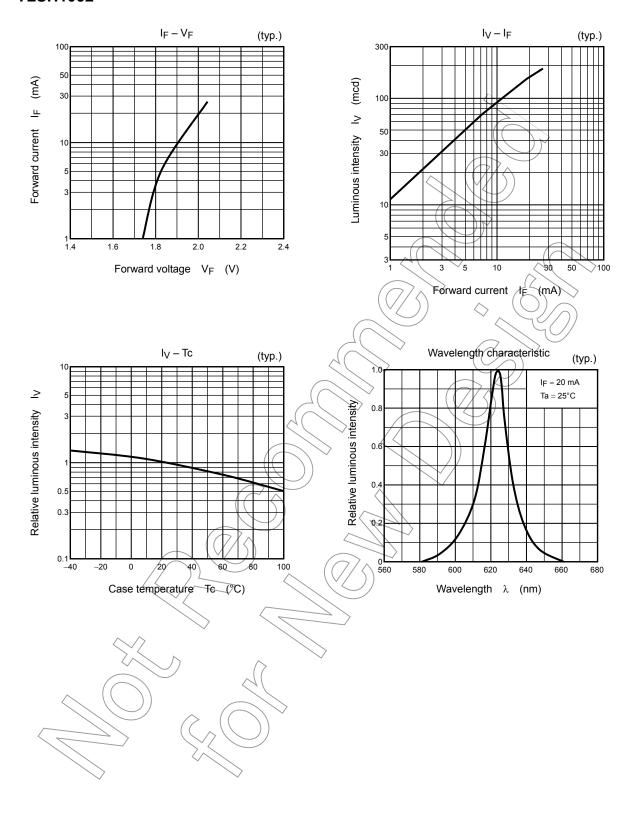
TLRH1032



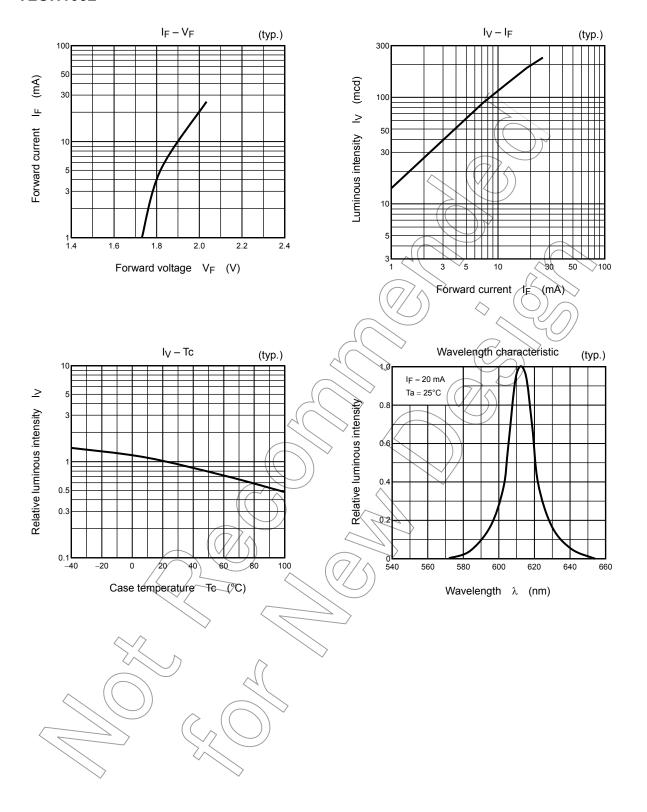
TLRMH1032



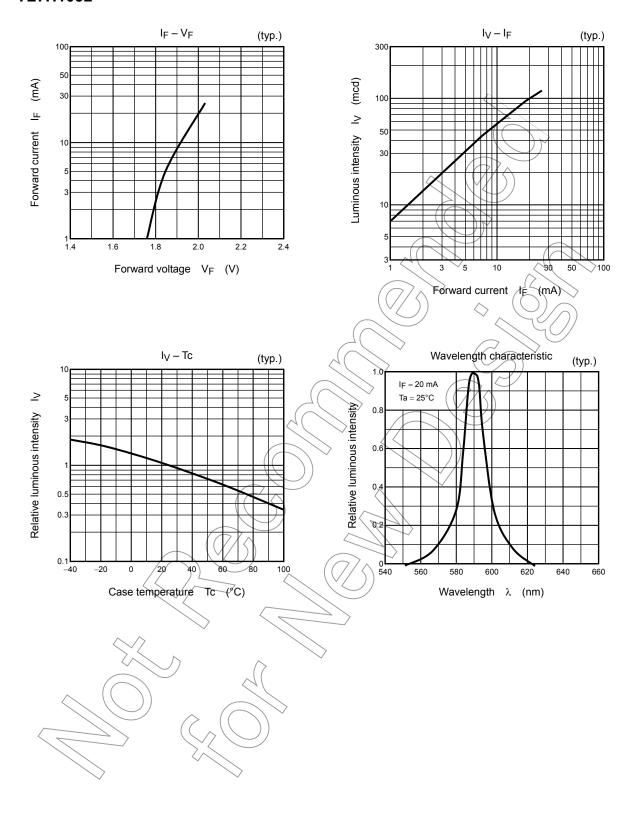
TLSH1032



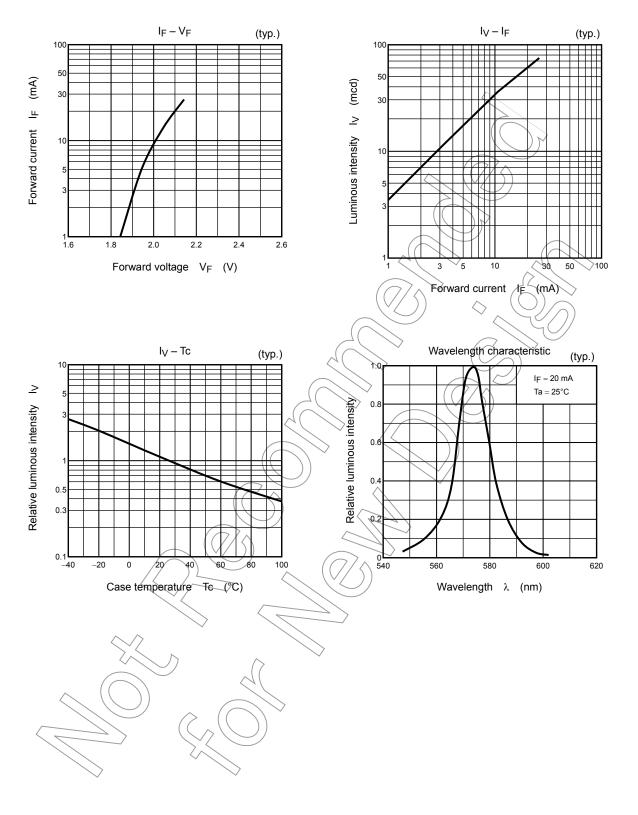
TLOH1032



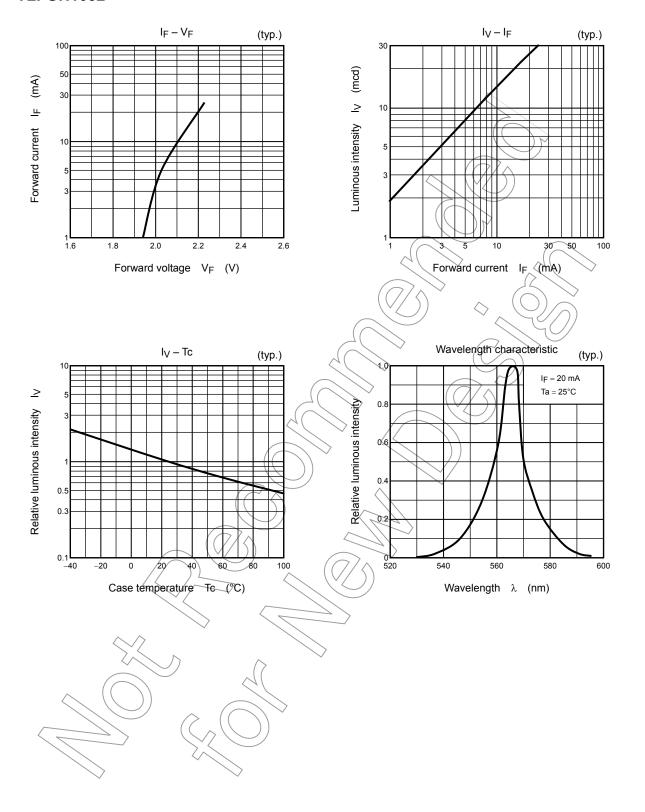
TLYH1032



TLGH1032

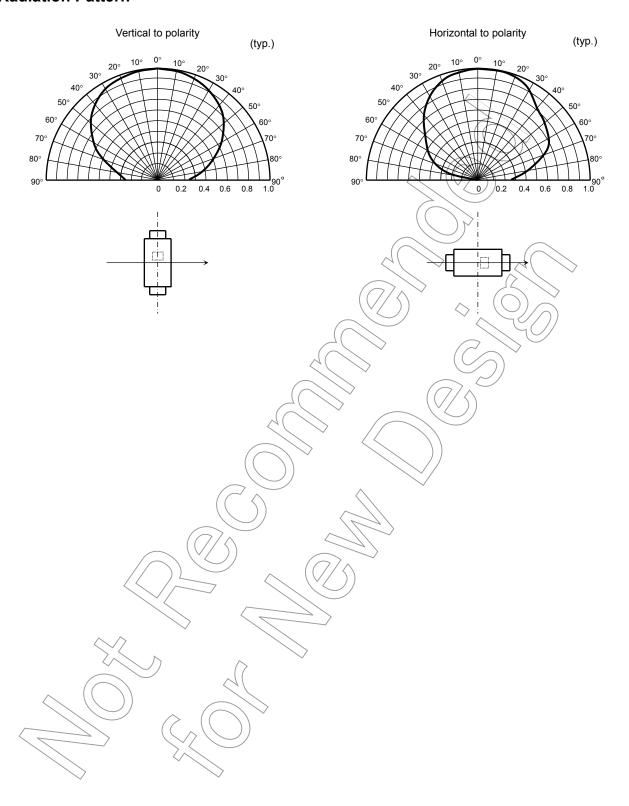


TLFGH1032





Radiation Pattern



Packaging

These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

1. This moisture proof bag may be stored unopened within 12 months at the following conditions. Temperature: 5°C to 30°C

Humidity: 90% (max)

- 2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/70% RH or below.
- 3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.

 After baking, use the baked devices within 72 hours, but perform baking only once.

 Baking conditions: 60±5°C, for 12 to 24 hours.

Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.

4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting. Furthermore, prevent the devices from being destructed against static electricity for baking of it.

5. If the packing material of laminate would be broken, the air tightness would deteriorate. Therefore, do not throw or drop the packed devices.

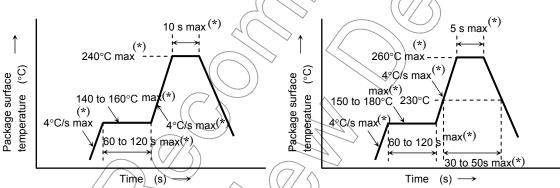
Mounting Method

Soldering

• Reflow soldering (example)

Temperature profile for Pb soldering (example)

Temperature profile for Pb-free soldering (example)



- The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.

Second reflow soldering

In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.

Storage conditions before the second reflow soldering: 30°C, 70% RH (max)

Make any necessary soldering corrections manually.

(only once at each soldering point)

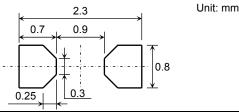
Soldering iron: 25 W

Temperature: 300°C or less Time: within 3 s

 If the products need to be performed by other soldering method (ex. wave soldering), please contact Toshiba sales representative.

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Recommended soldering pattern



Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents. It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES: (made by ASAHI GLASS)

KAO CLEAN THROUGH 750H: (made by KAO)

PINE ALPHA ST-100S: (made by ARAKAWA CHEMICAL

Precaution when mounting

Do not apply force to the plastic part of the LED under high-temperature conditions.

To avoid damaging the LED plastic, do not apply friction using a hard material.

When installing the PCB in a product, ensure that the device does not come into contact with other emponents.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (However, this method does not apply to products whose electrical/optical characteristics differ from standard Toshiba specifications)

- (1) Tape Type: T15 (2-mm pitch)
- (2) Example

TLRH1032 (T15,F)
Pb-free product
Tape type
Toshiba product No

2. Handling precautions

Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

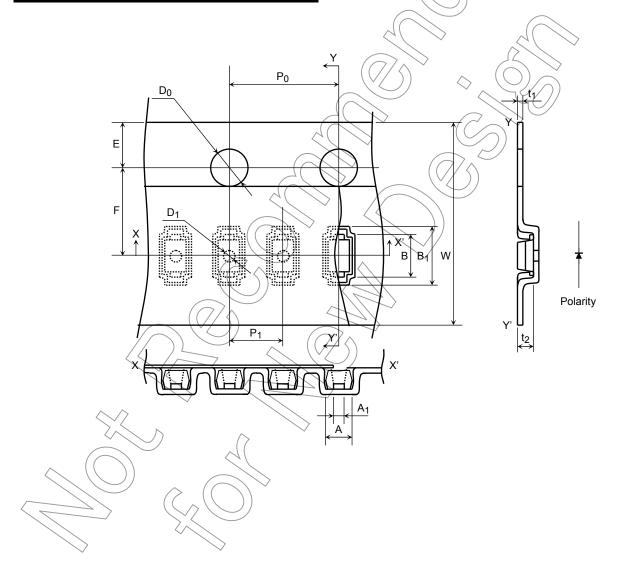
- (a) Since tape materials may accumulate an electrostatic charge, use an ionizer to neutralize the ambient air.
- (b) For transport and temporary storage of devices, use containers (boxes and bags) and jigs that are made of anti-static materials or of materials which dissipate electrostatic charge.



3. Tape dimensions

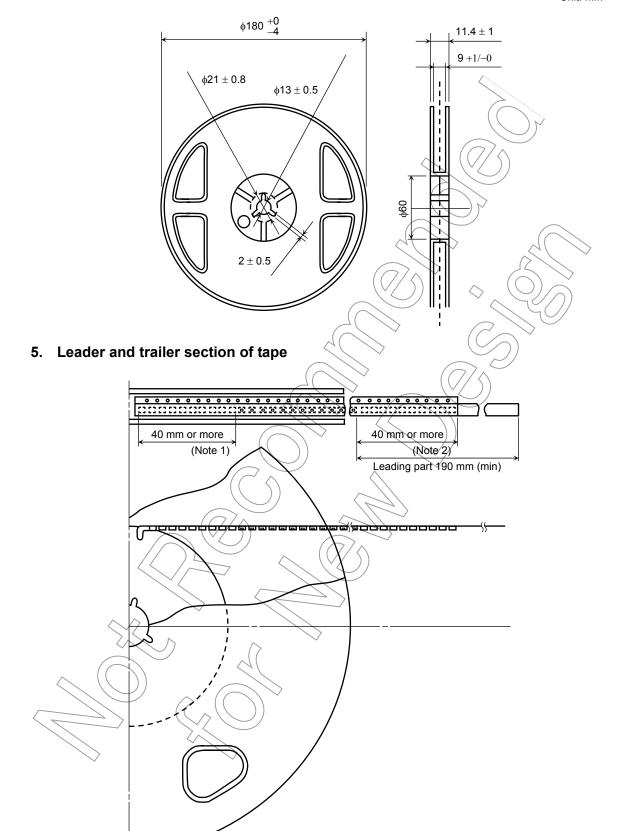
Ite	Item		Value	Tolerance
Carrier tape	Width	W	8.0	±0.2
Carrier tape	Thickness	t ₁	0.2	±0.05
	Diameter	D ₀	1.50	+0.1/-0
Feed hole	Pitch	P ₀	4.0	±0.1
	Position	Е	1.75	±0.1
Distance form center	Vertical Direction	P ₁	2.0	±0.1
line	Horizontal Direction	F	3.5	±0.1

				Unit: mm
lte	Item		Value	Tolerance
	Length	B ₁	1.85	±0.05
		В	1.3	±0.05
	Width	A	0.9	±0.05
Cavity	VVIGUI	(A ₁)	0.37	±0.05
	Depth Diameter of mark hole	t ₂	0.52	±0.05
		D 1	0.5	±0.05



4. Reel dimensions

Unit: mm



Note 1: Empty trailer section

Note 2: Empty leader section



6. Packing display

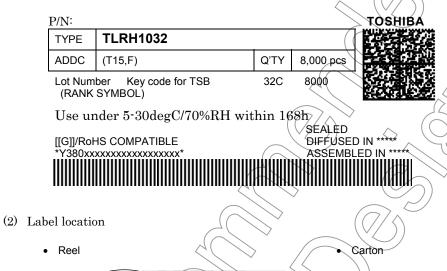
(1) Packing quantity

Reel	8,000 pcs
Carton	40,000 pcs

(2) Package form: Each reel is sealed in an aluminum pack with silica gel.

7. Label format

(1) Example: TLRH1032 (T15,F)



Tape reel direction

The aluminum package in which the reel is supplied also has a copy of the label attached to center of one side.

Label position

Label position



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